VSMY3940X01



Vishay Semiconductors

High Speed Infrared Emitting Diode, 940 nm, Surface Emitter Technology



As part of the <u>SurfLight</u>[™] portfolio, the VSMY3940X01 is an infrared, 940 nm emitting diode based on surface emitter

technology with high radiant intensity, high optical power

and high speed, molded in a PLCC-2 package for surface

FEATURES

- Package type: surface mount
- Package form: PLCC-2
- Dimensions (L x W x H in mm): 3.5 x 2.8 x 1.75
- AEC-Q101 gualified
- Peak wavelength: $\lambda_p = 940 \text{ nm}$
- High reliability
- · High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 60^{\circ}$
- Suitable for high pulse current operation
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RELEASED FOR APPLICATIONS

Infrared radiation source for operation with CMOS cameras (illumination)

- High speed IR data transmission
- · IR touch panels
- 3D TV
- · Light curtain

PRODUCT SUMMARY COMPONENT l_e (mW/sr) λ_P (nm) φ (deg) t_r (ns) VSMY3940X01 15 ± 60 940 10

Note

DESCRIPTION

mounting (SMD).

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION							
ORDERING CODE	PACKAGING	AGING REMARKS P/					
VSMY3940X01-GS08	Tape and reel	MOQ: 7500 pcs, 1500 pcs/reel	PLCC-2				
VSMY3940X01-GS18	Tape and reel	MOQ: 8000 pcs, 8000 pcs/reel	PLCC-2				

Note

· MOQ: minimum order quantity





VSMY3940X01



Vishay Semiconductors

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Reverse voltage		V _R	5	V		
Forward current		I _F	100	mA		
Pulse peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA		
Surge forward current	t _p = 100 μs	I _{FSM}	1	A		
Power dissipation		Pv	190	mW		
Junction temperature		Tj	100	°C		
Operating temperature range		T _{amb}	-40 to +85	°C		
Storage temperature range		T _{stg}	-40 to +100	°C		
Soldering temperature	acc. figure 10, J-STD-020	T _{sd}	260	°C		
Thermal resistance junction/ambient	J-STD-051, soldered on PCB	R _{thJA}	250	K/W		

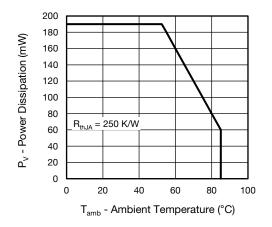


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

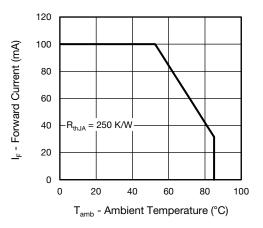


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Forward voltage	l _F = 100 mA, t _p = 20 ms	V _F		1.44	1.9	V		
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	V _F		2.2		V		
Temperature coefficient of V_F	I _F = 100 mA	TK _{VF}		-1.6		mV/K		
Reverse current		I _R	not designed for reverse operation			μA		
Junction capacitance	V _R = 0 V, f = 1 MHz, E = 0	Cj		125		pF		
Radiant intensity	l _F = 100 mA, t _p = 20 ms	l _e	8	15	24	mW/sr		
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	l _e		120		mW/sr		
Radiant power	l _F = 100 mA, t _p = 20 ms	фe		55		mW		
Temperature coefficient of ϕ_{e}	I _F = 100 mA	TKφ _e		-0.25		%/K		
Angle of half intensity		φ		± 60		deg		
Peak wavelength	I _F = 20 mA	λρ	920	940	960	nm		
Spectral bandwidth	I _F = 30 mA	Δλ		40		nm		
Temperature coefficient of λ_p	I _F = 100 mA	ΤΚλρ		0.25		nm/K		
Rise time	I _F = 100 mA	t _r		10		ns		
Fall time	I _F = 100 mA	t _f		10		ns		

Rev. 1.2, 25-Jun-14

Document Number: 84220



Vishay Semiconductors

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

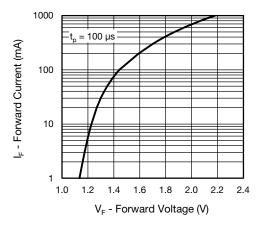


Fig. 3 - Forward Current vs. Forward Voltage

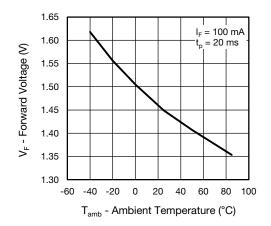


Fig. 4 - Forward Voltage vs. Ambient Temperature

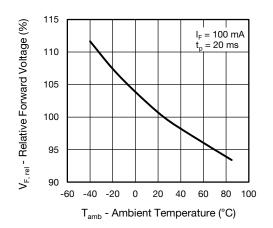


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

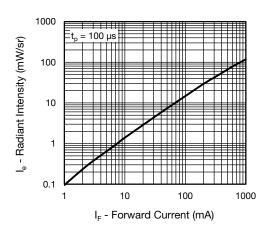


Fig. 6 - Radiant Intensity vs. Forward Current

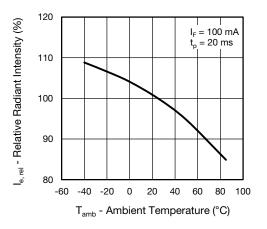


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

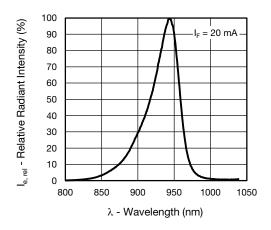


Fig. 8 - Relative Radiant Intensity vs. Wavelength

3 For technical questions, contact: <u>emittertechsupport@vishay.com</u>

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000



VSMY3940X01

Vishay Semiconductors

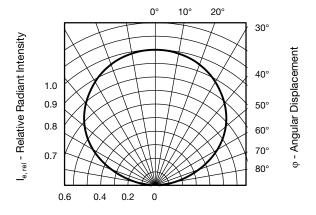
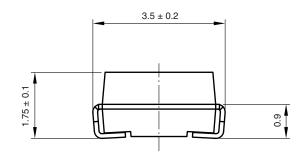
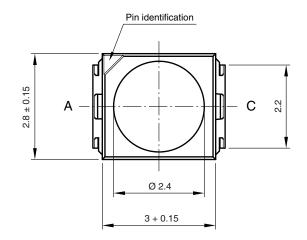


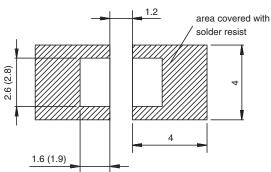
Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

PACKAGE DIMENSIONS in millimeters









Mounting Pad Layout

4

Drawing-No.: 6.541-5067.02-4 Issue: 4; 19.07.10 20767

Vishay Semiconductors



SOLDER PROFILE

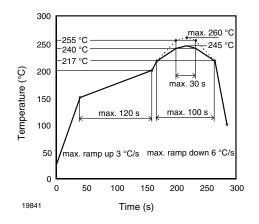


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

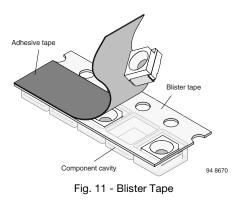
Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label: Floor life: 168 h Conditions: $T_{amb} < 30$ °C, RH < 60 % Moisture sensitivity level 3, acc. to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

TAPE AND REEL

PLCC-2 components are packed in antistatic blister tape (DIN IEC (CO) 564) for automatic component insertion. Cavities of blister tape are covered with adhesive tape.



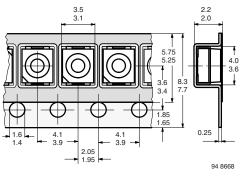
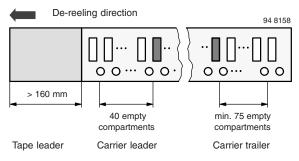


Fig. 12 - Tape Dimensions in mm for PLCC-2

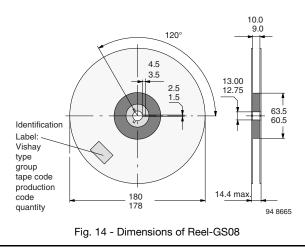
MISSING DEVICES

A maximum of 0.5 % of the total number of components per reel may be missing, exclusively missing components at the beginning and at the end of the reel. A maximum of three consecutive components may be missing, provided this gap is followed by six consecutive components.





The tape leader is at least 160 mm and is followed by a carrier tape leader with at least 40 empty compartments. The tape leader may include the carrier tape as long as the cover tape is not connected to the carrier tape. The least component is followed by a carrier tape trailer with a least 75 empty compartments and sealed with cover tape.



5

Document Number: 84220



Vishay Semiconductors



The removal force lies between 0.1 N and 1.0 N at a removal speed of 5 mm/s. In order to prevent components from popping out of the blisters, the cover tape must be pulled off at an angle of 180° with regard to the feed direction.

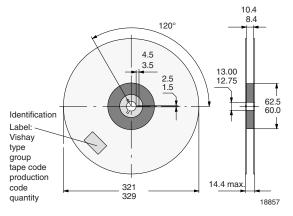


Fig. 15 - Dimensions of Reel-GS18



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Infrared Emitters - High Power category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

TSHA6201 TSHA6202 SFH 4030 SFH 4060 SFH 4775S A01 SFH 4726AS SFH 4725AS VSMY2853SLX01 VSMY2853RGX01 VSMY2853GX01 VSMY2850GX01 IN-P281ASGHIR IN-P281ASGIR VSMY2890GX01 VSMY2890RGX01 SFH 4728AS A01 SST-10-IRD-B130H-S940 SST-10-IRD-B50H-S940 QEE123 TSHA6200 TSML1030 VTE1291W-2H LL-304IRC4B-2AD LL-503HIRT2E-1CC LL-503IRC2E-2AC LL-503IRC2V-2AD LL-503IRT2E-2AC LL-503IRT2E-2AE LL-503SIRC2E-1BD LL-S170IRC-2A SFH 4259 OS5RKAZ5D1P OSB56LZE31D OSG58AZ5D1P OSI3CA5111A OSI3NAS1C1A OSI5LA56A1A OSI5XNE3E1E OSIXCA5121A OSIXCAS1C1A OSM54LZ5D1P OSM5D3Z2C1P OSMR43Z2C1P OSO5PAZ161D OSOR7161D OSPW7161D OSPW71B1P OSR5PAZE31D OSR9XAE3E1E OSRICA3131A